



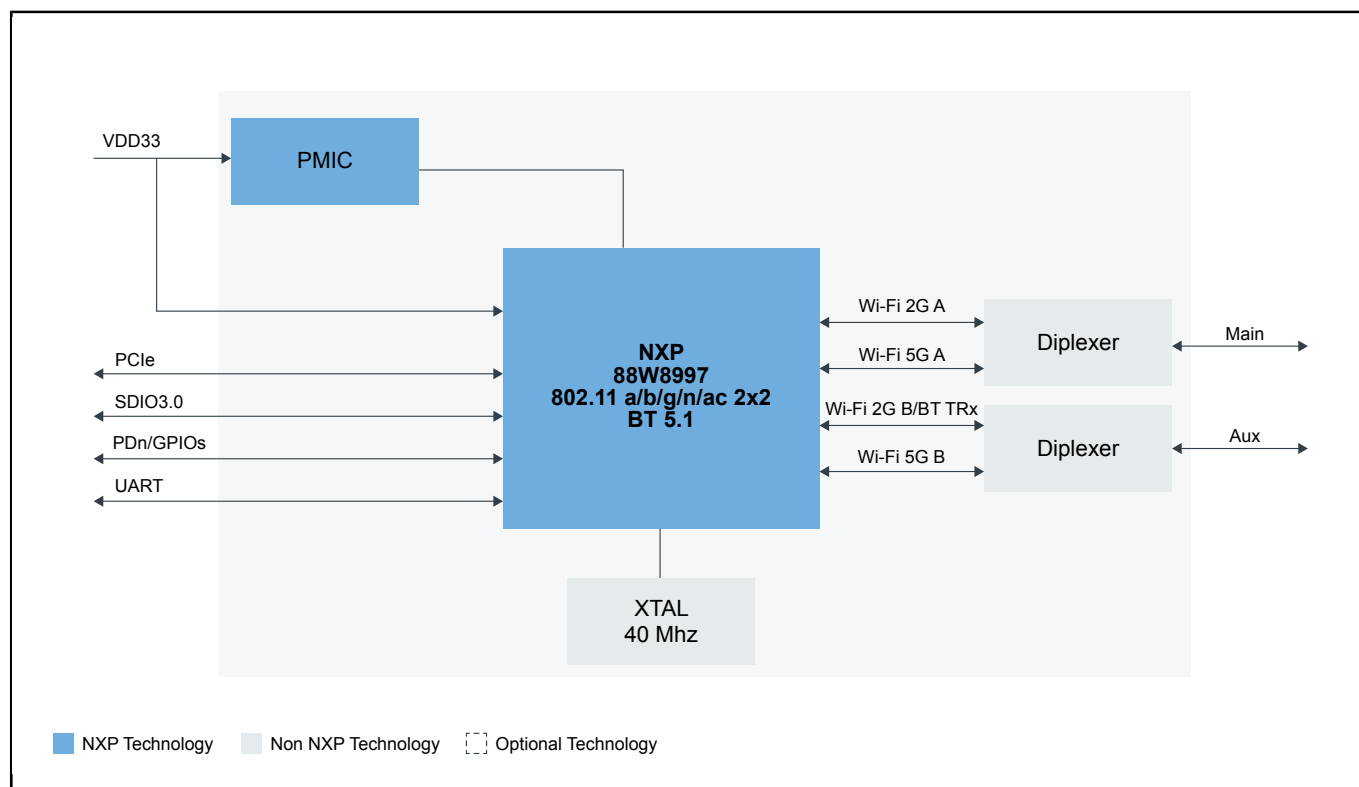
Advantech's EWM-W306: NXP 88W8997 M.2 1216

EWM-W306

Last Updated: Jun 22, 2023

Advantech EWM-W306 is NXP88W8997 M.2 1216 solder down module, supporting 802.11ac and Bluetooth® 5.1 2x2 dual band. This wide range temperature module can use in medical device, handheld device, industrial application, embedded board and transportation.

EWM-W306 Block Diagram Block Diagram



View additional information for [Advantech's EWM-W306: NXP 88W8997 M.2 1216](#).

Note: The information on this document is subject to change without notice.

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